

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

TAGUCHI ET AL

Application No.:

Art Unit:

Filed: August 22, 2000

For: LEAD-FREE SOLDER PASTE FOR REFLOW SOLDERING

JC892 U.S. PTO

09/642765



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D.O.

2-5-01

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Pursuant to the requirements of 37 CFR §§1.56 and 1.97, the attention of the Examiner is directed to the documents listed on the attached Form PTO-1449. A copy of each of the listed documents is attached. Neither this Statement nor the listing of these documents on Form PTO-1449 is an admission that these documents are prior art as to Applicants or a representation that a search has been made or that no more pertinent documents exist.

Applicants respectfully request that the attached documents be considered by the Examiner and made of record in the

referenced patent application.

Respectfully submitted,



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